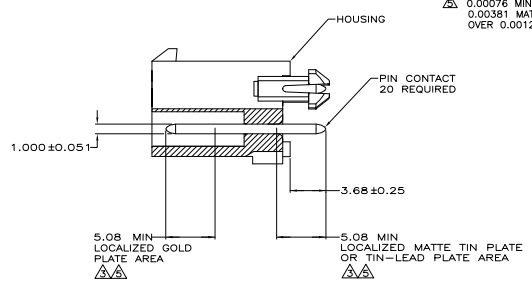
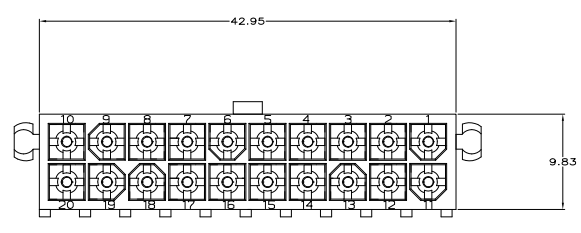
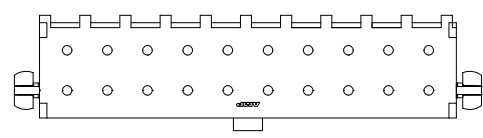
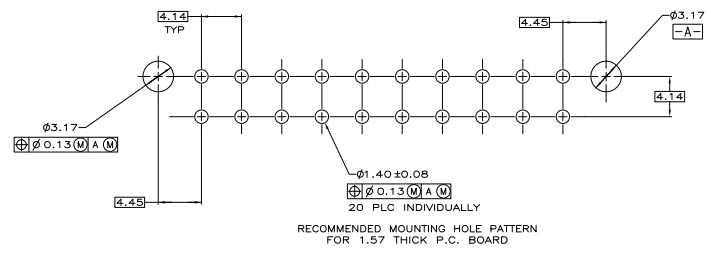
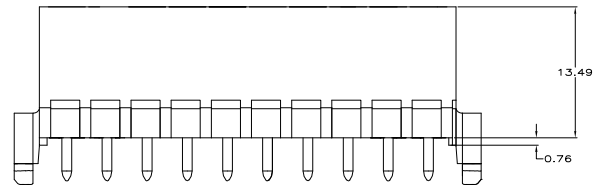


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REV	DATE	DESCRIPTION	BY	CHK
0				
D1		REVISED PER EDO-07-007242	11M907	KW CJ



- PINS TO COMPLY WITH AMP SOLDERABILITY SPEC. 108-11-3.
 - 0.00381 MIN MATTE TIN LEAD OVER 0.00127 MIN NICKEL.
 - 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
 - 0.00381 MIN MATTE TIN OVER 0.00127 MIN NICKEL.
 - 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.



PIN CONTACT MATERIAL AND FINISH	HOUSING MATERIAL AND COLOR	PART NUMBER
BRASS, GOLD	NYLON, 94V-0, WHITE	1-794077-1
BRASS, TIN	NYLON, 94V-0, WHITE	1-794077-0
BRASS, GOLD	NYLON, 94V-0, WHITE	794077-2
BRASS, TIN LEAD	NYLON, 94V-0, WHITE	794077-1

THIS DRAWING IS A CONTROLLED DOCUMENT. DATE: 11-18-08. TTI ELECTRONICS CORPORATION, Harrisburg, Pa 17105-3008.

DESIGNER: [] CHECKED: [] DATE: 11-18-08

PROJECT: []

DESCRIPTION: HEADER ASSEMBLY, CLOSED BOTTOM, 20 CIRCUIT, DOUBLE ROW VERTICAL, MINI-UNIVERSAL, MATE-N-LOCK™

SIZE: A1 (00779) (C=794077)

REVISIONS: []

DATE: 11-18-08

CUSTOMER DRAWING

